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- Inputs Are TTL-Voltage Compatible
- *EPIC*[™] (Enhanced-Performance Implanted CMOS) Process
- High Latch-Up Immunity Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), and Thin Shrink Small-Outline (PW) Packages, Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

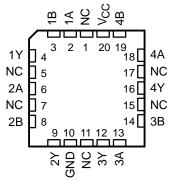
The 'AHCT08 are quadruple 2-input positive-AND gates. These devices perform the Boolean function $Y = A \bullet B$ or $Y = \overline{A + B}$ in positive logic.

The SN54AHCT08 is characterized for operation over the full military temperature range of -55° C to 125°C. The SN74AHCT08 is characterized for operation from -40° C to 85°C.

SN54AH	CT08 J OR W PACKAGE
SN74AHCT08	. D, DB, DGV, N, OR PW PACKAGE
	(TOP VIEW)

-,
4 V _{CC} 3 4B 2 4A 1 4Y 0 3B 9 3A
8 3Y

SN54AHCT08 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

	(each g	ate)							
INP	INPUTS OUTPU								
Α	В	Y							
Н	Н	Н							
L	Х	L							
Х	L	L							

FUNCTION TABLE

EPIC is a tr

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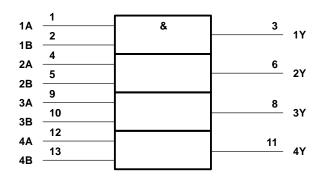
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, DB, DGV, J, N, PW, and W packages.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage range, V _{CC} Input voltage range, V _I (see Note 1)		
Output voltage range, V _O (see Note 1)		V to V_{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)		–20 mA
Output clamp current, I_{OK} (V _O < 0 or V _O > V _{CC}		±20 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$		±25 mA
Continuous current through V _{CC} or GND		±50 mA
Package thermal impedance, θ_{JA} (see Note 2):		
	DB package	158°C/W
	DGV package	182°C/W
	N package	78°C/W
	PW package	170°C/W
Storage temperature range, T _{stg}		. –65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.



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recommended operating conditions (see Note 3)

		SN54AHCT08		CT08 SN74AHCT08		UNIT
		MIN	MAX	MIN	MAX	UNIT
V _{CC}	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2		2		V
\vee_{IL}	Low-level input voltage		0.8		0.8	V
VI	Input voltage	0	5.5	0	5.5	V
Vo	Output voltage	0	VCC	0	VCC	V
ЮН	High-level output current		-8		-8	mA
IOL	Low-level output current		8		8	mA
$\Delta t/\Delta v$	Input transition rise or fall rate		20		20	ns/V
Т _А	Operating free-air temperature	-55	125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vaa	Τį	λ = 25°C	;	SN54A	HCT08	SN74A	HCT08	UNIT
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
Veu	I _{OH} = -50 μA	4.5 V	4.4	4.5		4.4		4.4		V
Voh	I _{OH} = –8 mA	4.5 V	3.94			3.8		3.8		v
Vei	I _{OL} = 50 μA	4.5 V			0.1		0.1		0.1	V
VOL	I _{OL} = 8 mA	4.5 V			0.36		0.44		0.44	v
Ц	$V_{I} = V_{CC} \text{ or GND}$	5.5 V			±0.1		±1		±1	μA
ICC	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			2		20		20	μA
∆lCC‡	One input at 3.4 V, Other inputs at V _{CC} or GND	5.5 V			1.35		1.5		1.5	mA
Ci	$V_I = V_{CC}$ or GND	5 V		4	10				10	pF

[†] This is the increase in supply current for each input at one of the specified TTL voltage levels rather than 0 V or V_{CC}.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

		TO LOAD (OUTPUT) CAPACITANCE			SN	54AHCT	08																	
PARAMETER	FROM (INPUT)			-	Т	ן = 25°C	;	MIN	МАХ	UNIT														
	(OAI AONANOE	MIN	TYP	MAX		MAX																
^t PLH [*]	A or B	V	CL = 15 pF		5	6.9	1	8	ns															
^t PHL [*]	AOLP	Y	I	I	Ι	I	I	I	I	Ι	Ι	I	I	I	ľ	I				5	6.9	1	8	115
^t PLH	A or B	V	$C_{1} = 50 \text{ pE}$		5.5	7.9	1	9	ns															
^t PHL	AUD		C _L = 50 pF		5.5	7.9	1	9	115															

* On products compliant to MIL-PRF-38535, this parameter is warranted but not production tested.



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switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

				SN74AHCT				ī 0 8			
PARAMETER	FROM (INPUT)	TO LOAD (OUTPUT) CAPACITANCE	Τ ₄	∖ = 25°C	;	MIN	МАХ	UNIT			
				MIN	TYP	MAX		WAA			
^t PLH	A or B	V	CL = 15 pF		5	6.9	1	8	ns		
^t PHL	AUB	Ŷ	Ι	I	CL = 15 pF		5	6.9	1	8	115
^t PLH	A or B	V			5.5	7.9	1	9	200		
^t PHL	AUB	I I	CL = 50 pF		5.5	7.9	1	9	ns		

noise characteristics, V_{CC} = 5 V, C_L = 50 pF, T_A = 25°C (see Note 4)

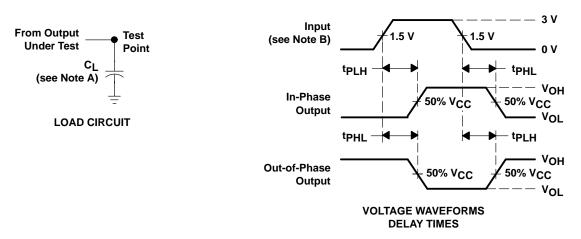
	PARAMETER		SN74AHCT08		
	FARAMETER	MIN	TYP	MAX	UNIT
V _{OL(P)}	Quiet output, maximum dynamic V _{OL}		0.4	0.8	V
VOL(V)	Quiet output, minimum dynamic V _{OL}		-0.4	-0.8	V
VOH(V)	Quiet output, minimum dynamic V _{OH}	4.4			V
VIH(D)	High-level dynamic input voltage	2			V
V _{IL(D)}	Low-level dynamic input voltage			0.8	V

NOTE 4: Characteristics are for surface-mount packages only. These parameters are warranted but not production tested.

operating characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

PARAMETER		TEST CO	ONDITIONS	TYP	UNIT
Cpd	Power dissipation capacitance	No load,	f = 1 MHz	18	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. $\ensuremath{\mathsf{C}}\xspace_L$ includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 3 ns, t_f = 3 ns.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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